Features

- Watchdog Adjustable
- Over- and Undervoltage Detection of $V_{cc} = 5V$
- Standby Modes On/Off via Ignition Pin VKL15
- Internal Time Delay for Output Signal
- Push-pull Output Driver
- Interference and Damage Protection According to ISO/CD 7637
- ESD Protection

1. Description

The ATA6025 is a monolithic circuit based on Atmel's smart power BCD60-III technology. It is a universal IC for monitoring basic functions of an automotive application. It is possible to monitor the battery voltage (VKL15) and an external 5V voltage regulator. With the independent watchdog the correct function of a microcontroller can be observed. If a failure occurs, the output NOTL switches to high after a time delay. During standby mode the current consumption is reduced to a minimum.



Watchdog IC

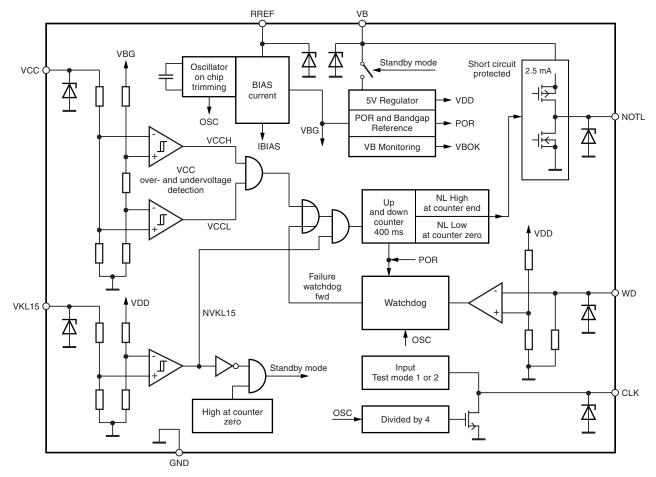
ATA6025

Rev. 4716C-AUTO-09/05





Figure 1-1. Block Diagram



2. Pin Configuration

Figure 2-1. Pinning SO8

	_			
NOTL VB		1 2	8 7	VCC CLK
GND RREF		3 4	6 5	WD VKL15

Table 2-1.Pin Description

Pin	Symbol	Function
1	NOTL	Push-pull output driver
2	VB	Voltage supply
3	GND	Ground
4	RREF	Reference voltage to adjust oscillator frequency via resistor Rset
5	VKL15	Input for standby modes on/of via ignition KL15
6	WD	Input for watchdog signal from microcontroller
7	CLK	Clock output signal, open drain
8	VCC	Input for monitoring 5V power supply





3. Functional Description

3.1 Voltage Supply

The IC can be supplied directly from $V_{battery}$. If the voltage at the VB pin is lower than the threshold of $V_{VBlo} = 5.76$ V, the internal signal V_{BOK} is set to low. If V_{BOK} is low, the monitor function of the IC is completely disabled and the output NOTL is switched off in all cases (see Figure 8-3 on page 11).

If the voltage at pin VKL15 is low, the IC is in standby mode and reduces the current consumption at pin VB < 100 μ A.

3.2 Oscillator

The frequency f_{CLK} of the internal oscillator is defined by the external resistor RSET and the internal capacitor. Thus, it is possible to vary the oscillator frequency between 4 kHz and 24 kHz.

3.3 VKL15 Monitoring

This input is used to monitor the battery voltage at ignition pin VKL15. If the voltage $V_{KL15lo} < 1.8V$, the internal signal NVKL15 is set to high (see Figure 8-3 on page 11). The IC switches to standby mode. During standby mode the monitor function is disabled and the output NOTL is switched off after the time delay t_{Delav} .

If the output NOTL is switched on and the voltage at VKL15 switches suddenly to low, the internal timer starts and switches the NOTL off after a time delay of $t_{Delay} = 400$ ms.

3.4 VCC Over-/Undervoltage

Via the VCC input an external 5V voltage regulator is continuously monitored. If the voltage at pin VCC exceeds the voltage of $VCC_{hon} > 6.3V$, the failure bit VCCH is set high. If the voltage at pin VCC decreases to a value below $VCC_{lon} < 4V$, the internal failure bit VCCL will be set to high (see Figure 8-1 on page 10).

This failure bit starts the internal counter and switches the output NOTL on after the time delay of typically t_{Delay} = 400 ms.

If the VCC voltage is inside the tolerance $VCC_{loff} < V_{VCC} < VCC_{hoff}$ the failure signal will be reset and the internal counter counts back to zero. After a time delay of typically t_{Delay} = 400 ms, the output NOTL is switched off again.

3.5 Watchdog

A microcontroller can be monitored by a digital window watchdog which accepts an incoming trigger signal T_{WD} of a constant frequency at pin WD for correct operation. If the pulse width T_{WD} between two alternate edges exceeds the time window of $To_{WD} > 8.9$ ms or if there is no watchdog signal, the failure signal fwd (failure watchdog) is set. In case the pulse width T_{WD} between two alternate edges falls below the time window of $Tu_{WD} < 2.6$ ms, the failure signal fwd (failure watchdog) is also set. With this fwd signal the internal up counter is activated and after a time delay of $t_{Delav} = 400$ ms, the output NOTL is switched to high.

If NOTL is high, 16 successive correct watchdog signals T_{WD} within the pulse width of $Tu_{WD} < T_{WD} < To_{WD}$ are needed to create the internal signal nfwd (no failure watchdog) to start the down counter. After a time delay of t_{Delay} = 400 ms, the output NOTL is switched to low (see Figure 8-2 on page 10).

3.6 Time Delay

The internal time delay is generated by an up/down counter. The clock for the counter is disabled if the voltage at the supply pin VB < 5.76V. In this case, the internal signal VBOK will be set to low and the output NOTL is directly switched to low.

The direction of counting is set by the watchdog or VCC over- and undervoltage detection. If the VCC monitoring detects an undervoltage condition, the failure signal VCCL (VCC low voltage) is set and starts the up counter. If the VCC monitoring detects an overvoltage condition, the failure signal VCCH (VCC high voltage) is set and starts the up counter.

A failure at the watchdog sets the internal fwd signal (failure watchdog) to high and starts the up counter. If the counter's final value is reached, a Flip Flop is set and switches the output NOTL to high. If no failure signal is set and the window watchdog has counted successive 16 alternate WDI edges then the down counter is started. If the counter reaches the zero value the Flip Flop receives a reset command and switches the output NOTL off.

The down counter is also started if the voltage at input VKL15 is low and switches the output NOTL after $t_{Delav} = 400$ ms to low (see Figure 8-3 on page 11).

3.7 Output NOTL

If the voltage at VKL15 is high and if a failure signal is set, the output NOTL switches to high after the internal time delay.

The output is short circuit protected with a current limitation of $ISC_{NOTL} = 15$ mA. The maximum output voltage is limited to $VC_{NOTL} = 22V$ (see Figure 8-4 on page 11).

3.8 Test Mode

The pin CLK is normally open or connected to GND. If the internal clock frequency is to be checked, the CLK pin has to be connected with an external resistor Rex = $5 \text{ k}\Omega$ to a 5V supply. The measured value is the clock frequency divided by four.





4. Truth Table

V _{VB}	V _{vcc}	WDI	VKL15	Mode
V < 5.76V	Do not coro	Do not care	Low	Standby, NOTL low
V _{VB} < 5.76V	76V Do not care		High	NOTL low
		Do not care	Low	Standby, NOTL low
	$V_{VCC} < 4V$	Do not care	High	NOTL high
		Do not care	Low	Standby, NOTL low
7.26V < V _{VB} < 17.5V	$4.8V < V_{VCC} < 5.2V$	No watchdog failure	High	NOTL low
		Watchdog failure	High	NOTL high
	$V_{VCC} > 6.3V$	Do not care	Low	Standby, NOTL low
	V _{VCC} > 6.3V	Do not care	High	NOTL high
		Do not care	Low	Standby, NOTL low
	$V_{VCC} < 4V$	Do not care	High	NOTL high (maximum 22 V)
		Do not care	Low	Standby, NOTL low
22V< V _{VB} < 40V	$4.8V < V_{VCC} < 5.2V$	No watchdog failure	High	NOTL low
		Watchdog failure	High	NOTL high (maximum 22 V)
	V _{VCC} > 6.3V	Do not care	Low	Standby, NOTL low
	V _{VCC} > 6.3V	Do not care	High	NOTL high

5. Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Parameters	Symbol	Min.	Max.	Unit
Supply voltage	V _{VB}	-0.3	+40	V
Voltage at pins VCC, WD	V _{VCC,} V _{WDI}	-0.3	+30	V
Voltage at pins RREF, CLK	V _{RREF,} V _{CLK}	-0.5	+6	V
Voltage at pin NOTL	V _{NOTL}	-0.3	+22	V
Voltage at pin KL15 (in series with external resistor of 50 k Ω 1%)	V _{KL15}	-0.1	+40	V
Maximum current at pin VCC	I _{VCC}	-100	+0.1	mA
Maximum current at pin VB	I _{VB}	-10	+10	mA
Maximum current in pins CLK, RREF, VKL15, NOTL		-100	+100	mA
Maximum current at pin WD	I _{WD}	-1	+1	mA
ESD classification HBM ESD S.5.1	all pins	2000		V
ESD classification MM JEDEC A115A	all pins	200		V
Power dissipation	P _V		300	mW
Chip temperature	TJ	-40	+150	°C
Operating ambient temperature	T _{amb}	-40	+125	°C
Storage temperature	T _{Stg}	-55	+150	°C

6. Thermal Resistance

Parameters	Symbol	Value	Unit
Thermal resistance from junction to ambient	R _{thJA}	160	K/W

7. Electrical Characteristics

 V_{VB} = 7.2V to 17.5V, RKL15 = 50 k Ω 1%, RSET = 22 k Ω 1%, T_{amb} = -40 to 125°C, unless otherwise specified

No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type'
0	Current Consumption	and ESD Clamping	1						1
0.1	Current consumption in normal mode	$V_{VKL15} > 4.5V$ $V_{VB} = 17.5V$ NOTL = high $I_{NOTL} = -2.5$ mA	2	I _{VB}			10	mA	A
0.2	Current consumption in standby mode	Standby: $V_{VKL15} < 1.8V$ $V_{VB} = 17.5V$ NOTL = low	2	I _{VBstby}			100	μA	A
0.3	Negative ESD clamping pin VB	to GND, I _{VB} = -10 mA	2	VN _{VB}	-1.4		-0.3	V	А
0.4	Positive ESD clamping pin RREF	to GND, I _{RREF} = 5 mA	4	VP _{RREF}	4		8	V	А
0.5	Positive ESD clamping pin CLK	to GND, I _{CLK} = 20 mA	7	VP _{CLK}	6		10	V	А
0.6	Positive ESD clamping pin VB	to GND, I _{VB} = 5 mA	2	VP _{VB}	41		65	V	А
0.7	Positive ESD clamping pin VKL15	to GND, I _{VKL15} = 1.6 mA	5	VP _{VKL15}	41		65	V	А
0.8	Positive ESD clamping pin NOTL	to GND, I _{NOTL} = 20 mA	1	VP _{NOTL}	31		55	V	А
0.9	Positive ESD clamping pin WD	to GND, I _{WD} = 0.7 mA	6	VP _{WD}	35		55	V	А
0.10	Positive ESD clamping pin VCC	to GND, I _{VCC} = 0.5 mA	8	VP _{VCC}	35		55	V	А
1	Reference Voltage								
1.1	Voltage at RREF		4	V _{RREF}	1.14	1.22	1.3	V	Α
1.2	Possible values of resistor RREF		4	R _{RREF}	10	22	50	kΩ	А
2	Oscillator								
2.1	Oscillator frequency	RSET = 22 kW ±1% at pin CLK with pull-up-resistor to +5 V	7	f _{CLK}	9	10	11	kHz	A
2.2	Oscillator frequency is variable in a range	RSE = 10 kΩto 50 kΩ±1%	7	f _{CLK}	3.96		24.2	kHz	А
4	VB Monitoring				·	·	·		
4.1	High level threshold		2	V _{VBhi}	5.94		7.26	V	Α
4.2	Low level threshold		2	V _{VBlo}	5.76		7.04	V	Α
4.3	Hysteresis		2	V _{VBhys}	0.2			V	Α

*) Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter





7. Electrical Characteristics (Continued) $V_{VR} = 7.2V$ to 17.5V, RKL15 = 50 k Ω 1%, RSET = 22 k Ω 1%, $T_{amb} = -40$ to 125°C, unless otherwise specified

No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
5	VKL15 Monitoring								
5.1	Input resistor at VKL15		5	Ri _{KL15}	18		70	kΩ	Α
5.2	Low voltage threshold	$RKL15 = 50 \text{ k}\Omega \pm 1\%$	5	VKL15 _{lo}	1.8			V	Α
5.3	High voltage threshold	$RKL15 = 50 \text{ k}\Omega \pm 1\%$	5	VKL15 _{hi}			4.5	V	Α
5.4	Hysteresis		5	VKL15 _{hys}	0.2		1	V	Α
6	VCC Monitoring					L		L	1
6.1	Pull-down resistor to GND at pin VCC	$V_{VB} = 17.5V$ $V_{VKL15} = 0V \text{ or}$ $V_{VKL15} = V_{VB}$ $V_{VCC} = 5V$	8	Rpd _{vcc}	50		350	kΩ	A
6.2	Undervoltage detection low level		8	VCCI _{on}	4			V	А
6.3	Undervoltage detection high level		8	VCCI _{off}			4.8	V	Α
6.4	Overvoltage detection high level		8	VCCI _{off}			6.3	V	Α
6.5	Overvoltage detection low level		8	VCCh _{off}	5.2			V	Α
6.6	Hysteresis of under- and overvoltage detection		8	VCC _{hys}	0.2			v	A
9	Oscillator Test					L		L	1
9.1	Pull-down-resistor	CLK = high, $V_{CLK} = 0V to 4.5V$	7	Rpd _{CLK}	6		15	kΩ	А
9.2	Saturation voltage	I _{CLK} = 1.6 mA, CLK = low	7	Vs _{CLK}			0.4	V	Α
9.3	Short current	$V_{CLK} = 5V, CLK = Iow$	7	Isc _{CLK}			10	mA	Α
10	Push-pull Output NOT	Ĺ							
10.1	Saturation voltage NOTL switched off	I _{NOTL} = 1.8 mA NOTL off	1	Vsat _{NOTLoff}			1	V	A
10.2	Short current NOTL if switched off	V _{NOTL} = V _{VB} NOTL off	1	Isc _{NOTLoff}			15	mA	Α
10.3	Maximum output voltage NOTL	$17.5V < V_{VB} < 30V$ $I_{NOTL} = -2.5 \text{ mA}$ NOTL on	1	V _{NOTLmax}	17.5		22	V	A
10.4	Saturation voltage NOTL switched on; guaranteed down to VB low level threshold	$\label{eq:Vsat_NOTLon} \begin{split} &Vsat_{NOTLon} = V_{VB} - V_{NOTL} \\ &V_{VKL15} = V_{VB} \\ &I_{NOTL} = -2.5 \text{ mA} \\ &NOTL \text{ on} \end{split}$	1	Vsat _{NOTLon}			0.25	V	A
10.5	Short current NOTL if switched off	V _{NOTL} = 0 V NOTL = on	1	Isc _{NOTLon}	-50			mA	Α
10.7	Time delay of internal up and down counter		1	t _{Delay}	360	400	450	ms	А

*) Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

7. Electrical Characteristics (Continued)

 $V_{VB} = 7.2V$ to 17.5V, RKL15 = 50 k Ω 1%, RSET = 22 k Ω 1%, $T_{amb} = -40$ to 125°C, unless otherwise specified

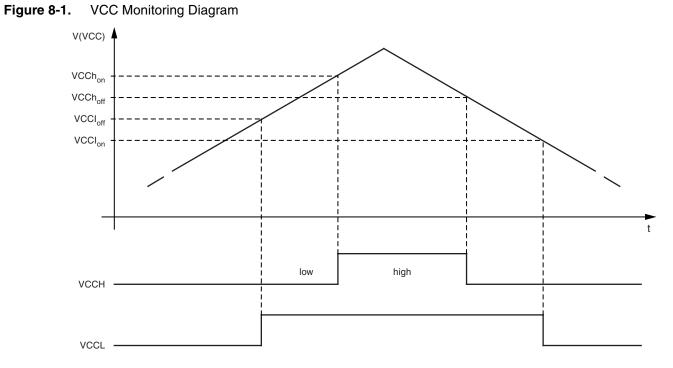
No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
10.8	Rise time at pin NOTL switch on	$\begin{array}{l} C_{\text{NOTL}} \leq 200 \text{ pF} \\ V_{\text{NOTL}} \text{ from low} = 10\% \text{ to} \\ \text{high} = 90\% \text{ V}_{\text{VB}} \end{array}$	1	tr _{NOTL}			5	μs	A
10.9	Fall time at pin NOTL switch off	$\begin{array}{l} C_{\text{NOTL}} \leq 200 \text{ pF} \\ V_{\text{NOTL}} \text{ from high} = 90\% \\ \text{to low} = 10\% \text{ V(VB)} \end{array}$	1	tf _{NOTL}			5	μs	A
11	Watchdog								-#
11.1	Pull-down-resistor	$V_{VB} = V_{KL15} = 17.5V$	6	Rpd _{wD}	30		200	kΩ	Α
11.2	Voltage threshold low		6	Vlow _{WD}	1			V	Α
11.3	Voltage threshold high		6	Vhigh _{WD}			3.5	V	Α
11.4	Hysteresis	Vhys _{WD} = Vhigh _{WD} – Vlow _{WD}	6	Vhys _{wD}	0.5			V	A
11.5	Acceptable low WD pulse width for failure	Pulse = high or low RSET = 22 k $\Omega \pm 1\%$	6	Tu _{WD}	2.6	3	3.3	ms	A
11.6	Acceptable high WD pulse width for failure	Pulse = high or low RSET = 22 k $\Omega \pm 1\%$	6	To _{WD}	7.1	8	8.9	ms	A

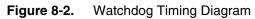
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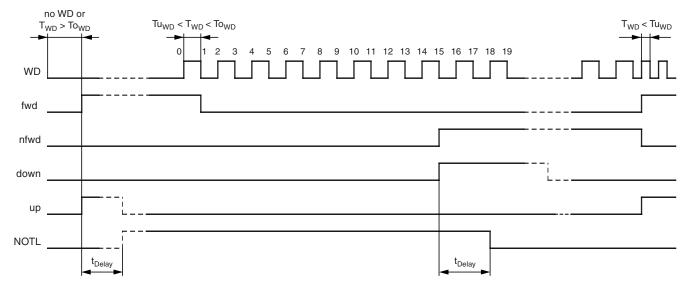




8. Diagrams







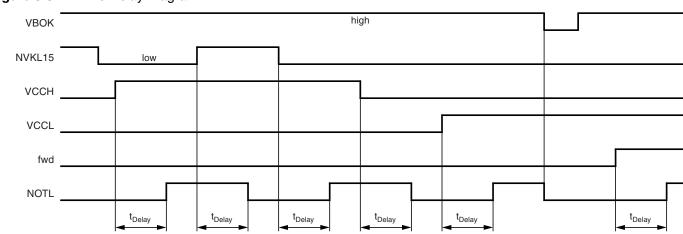
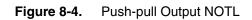


Figure 8-3. Time Delay Diagram



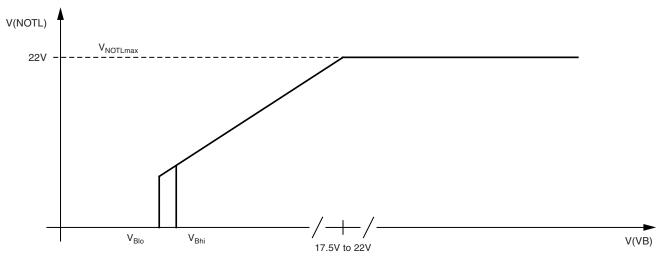
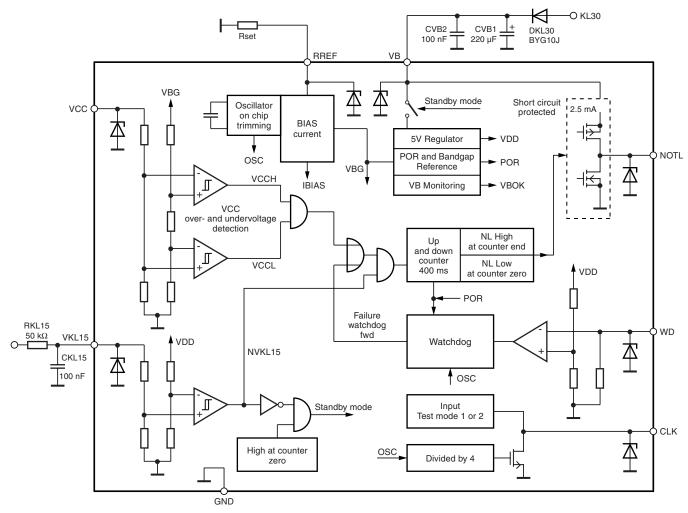






Figure 8-5. Application Circuit



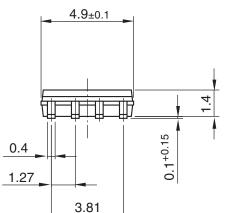
9. Ordering Information

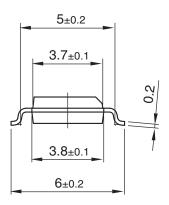
Extended Type Number	Package	Remarks
ATA6025-TAQY	SO8	Taped and reeled, Pb-free

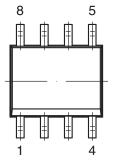
10. Package Information

Package: SO 8

Dimensions in mm









technical drawings according to DIN specifications

Drawing-No.: 6.541-5031.01-4 Issue: 1; 15.08.06

11. Revision History

Please note that the following page numbers referred to in this section refer to the specific revision mentioned, not to this document.

Revision No.	History
4716C-AUTO-09/05	 Put datasheet in a new template Pb-free logo on page 1 added Heading rows on Table "Absolute Maximum Ratings" on page 6 added
	 Ordering Information on page 13 changed





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